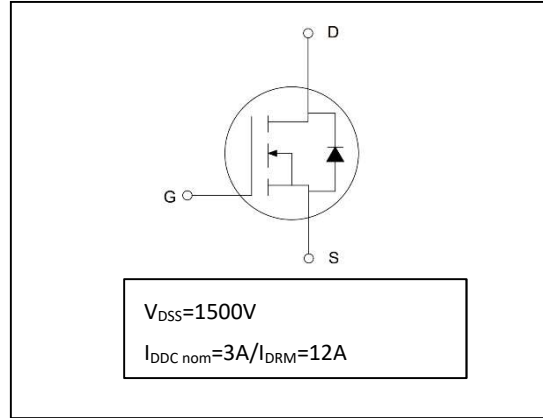
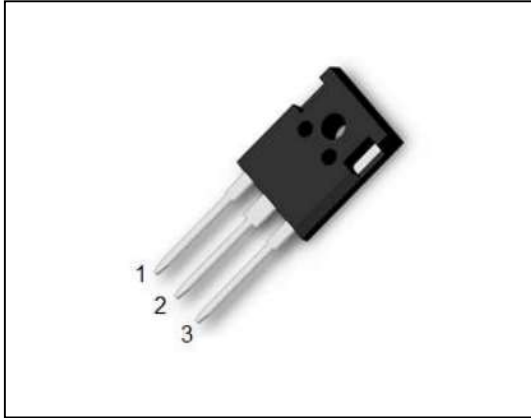


1500V 3A N-Channel MOS Discrete

1500V 3A MOSFET N-沟道 MOS 单管



Features:

- Fast Switching
- Low ON Resistance
- Low Gate Charge Minimize Switching loss
- Fast Recovery Body Diode

产品特性:

- 开关速度快
- 低 $R_{DS(ON)}$
- 低门级电荷最小化开关损耗
- 快恢复体二极管

Typical Applications:

- Adaptor
- Charger
- SMPS Standby Power

典型应用:

- 适配器
- 充电器
- 开关电源

MOSFET

Maximum Rated Values / 最大额定值

Item	Symbol	Conditions	Value	Units
漏极-源极电压 Drain-source voltage	V_{DS}	$T_{vj}=25^{\circ}\text{C}$	1500	V
漏极电流 Drain Current	I_D		3	A
脉冲漏极电流 Pulsed drain current	I_{DM}	Limited by T_{vjmax} . Maximum duty cycle $D=0.75$	12	A
功率损耗 Power dissipation	P_D	$T_{vj}=25^{\circ}\text{C}$	125	W
栅极峰值电压 Maximum gate-source voltage	V_{GS}		± 30	V
单脉冲雪崩耐量 Single Pulse Avalanche Energy	E_{AS}	Pulse width t_p limited by $T_{j,max}$	130	mJ

Characteristic Values / 特征值

Item	Symbol	Cond	Conditions	Min.	Typ.	Max.	Units
漏极-源极击穿电压 Drain-Source Breakdown Voltage	BV_{DSS}		$V_{GS}=0V, I_D=250\mu A, T_{vj}=25^{\circ}\text{C}$	1500			
漏极-源极通态电阻 Drain-source on resistance	$R_{DS(on)}$		$I_D=1.5A, V_{GS}=10V, T_{vj}=25^{\circ}\text{C}$		5.5	8.2	m Ω
栅极阈值电压 Gate threshold voltage	$V_{GS(th)}$		$I_C=0.25mA, V_{DS}=V_{GS}, T_{vj}=25^{\circ}\text{C}$	2.5		4.5	V
跨导 Transconductance	g_{fs}		$V_{DS} = 20 V, I_{DS} = 1.5A, T_{vj}=25^{\circ}\text{C}$		5		S
栅极电荷 Gate charge	Q_G Q_{GS} Q_{GD}		$V_{GS}=20V, I_D=1.5A, V_{DS}=750V$		62 23 19		nC
输入电容 Input capacitance	C_{iss}		$f=1MHz, T_{vj}=25^{\circ}\text{C}, V_{DS}=25V, V_{GS}=0V$		1740		pF
输出电容 Output capacitance	C_{oss}		$f=1MHz, T_{vj}=25^{\circ}\text{C}, V_{DS}=25V, V_{GS}=0V$		102		pF
反向传输电容 Reverse transfer capacitance	C_{rss}		$f=1MHz, T_{vj}=25^{\circ}\text{C}, V_{DS}=25V, V_{GS}=0V$		13		pF
漏极电流 Drain current	I_{DSS}		$V_{DS}=1500V, V_{GS}=0V, T_{vj}=25^{\circ}\text{C}$			10	μA
栅极-源极漏电流 Gate-source leakage current	I_{GSS}		$V_{DS}=0V, V_{GS}=\pm 30V, T_{vj}=25^{\circ}\text{C}$	-100		100	nA
开通延迟时间(电感负载) Turn-on delay time, inductive load	$t_{d(on)}$				33		ns
上升时间(电感负载) Rise time, inductive load	t_r				16		ns
关断延迟时间(电感负载) Turn-off delay time, inductive load	$t_{d(off)}$		$I_D=3A,$ $V_{DD}=750V$		58		ns
下降时间(电感负载) Fall time, inductive load	t_f		$V_{GS}=10V,$ $R_G=5\Omega,$		28		ns
结-外壳热阻 Thermal resistance, junction to case	R_{thJC}		$T_{vj}=25^{\circ}\text{C}$		1		K/W
结-环境热阻 Thermal resistance, junction to ambient	R_{thJA}				40		K/W
工作温度 Temperature under switching conditions	T_{vjop}			-40		150	$^{\circ}\text{C}$

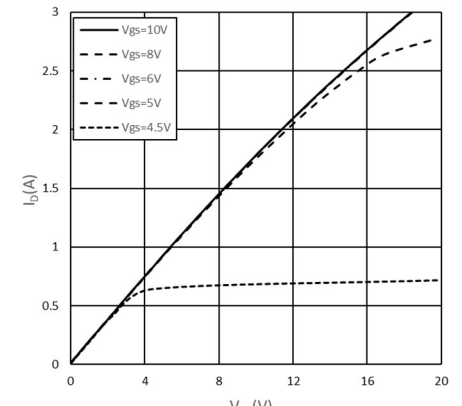
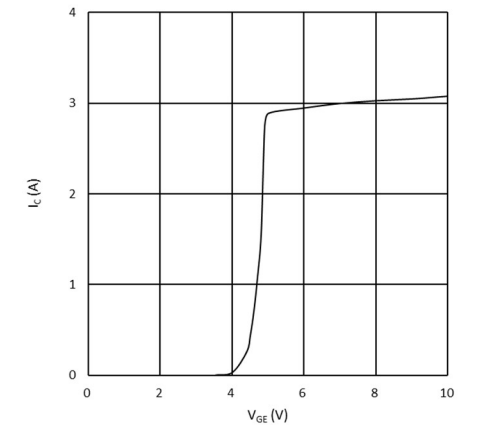
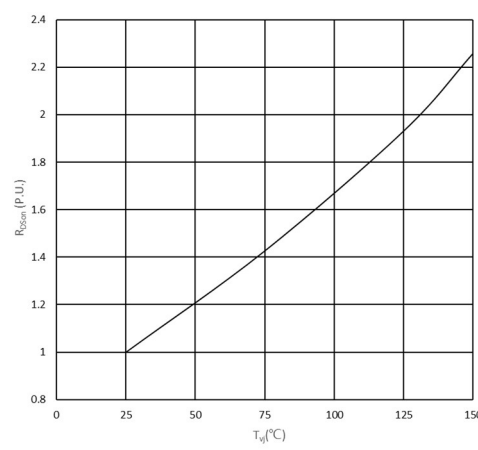
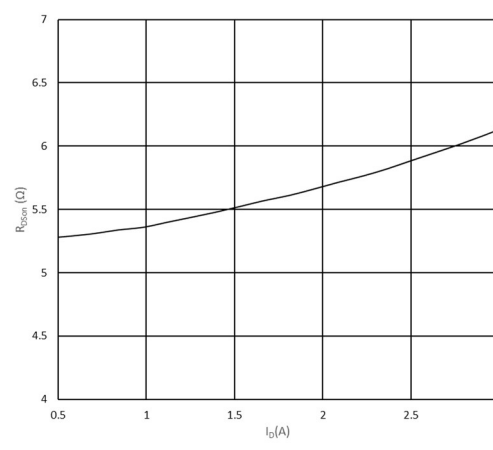
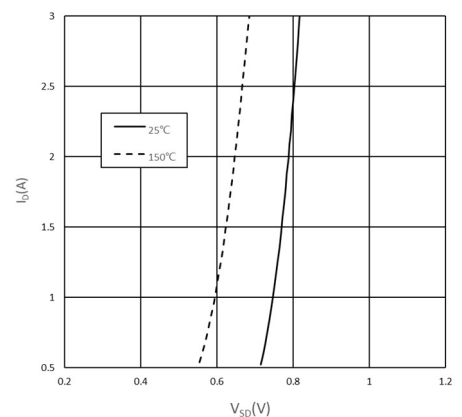
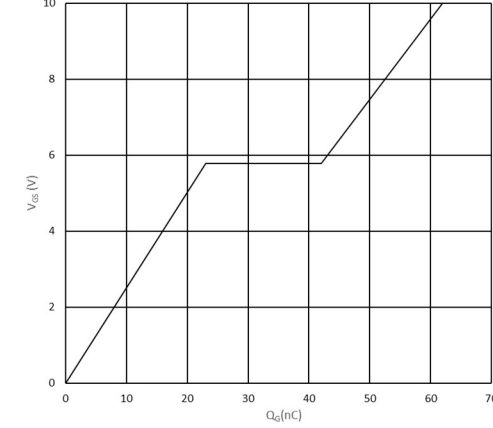
Body diode /体二极管

Maximum Rated Values /最大额定值

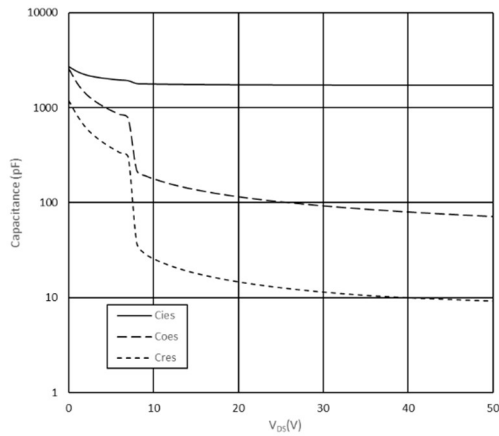
Item	Symbol	Conditions	Min.	Typ.	Max.	Units
连续反向漏极电流 Continuous reverse drain current	I_{SDC}	$V_{GS} = 0\text{ V}, T_C = 25^\circ\text{C}$			3	A
正向重复峰值电流 Peak repetitive forward current	I_{SM}	$V_{GS} = 0\text{ V}$, Pulse width t_p limited by T_{vjmax}			12	A

Characteristic Values / 特征值

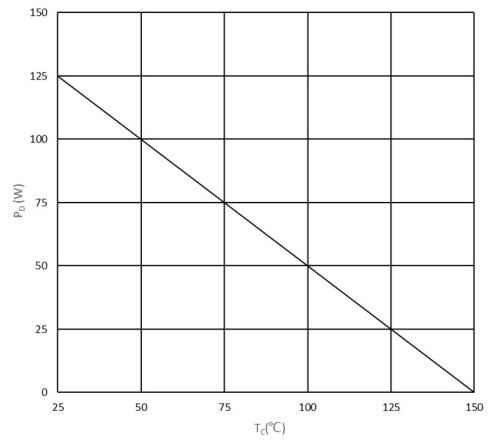
Item	Symbol	Conditions	Min.	Typ.	Max.	Units
正向电压 Forward voltage	V_{SD}	$I_{SD}=3\text{ A}, V_{GS}=0\text{ V}$ $T_{vj}=25^\circ\text{C}$			1.5	V
反向恢复时间 Reverse Recovery Time	T_{rr}	$I_{SD}=3\text{ A}$ $dI_F/dt=100\text{ A}/\mu\text{s}, V_{GS}=0\text{ V}$ $T_j=25^\circ\text{C}$		225		ns
反向恢复电荷 Reverse Recovery Charge	Q_{rr}			1.1		μC
工作温度 Temperature under switching conditions	T_{vjop}		-40		150	$^\circ\text{C}$

<p>输出特性 MOSFET Output characteristic MOSFET $I_{DS}=f(V_{DS}), T_{vj}=25^{\circ}\text{C}$</p>	<p>传输特性 MOSFET Transfer characteristic MOSFET $I_{DS}=f(V_{GS}), V_{DS}=20\text{V}, T_{vj}=25^{\circ}\text{C}$</p>
	
<p>归一化漏源通态电阻 Normalized Drain-source on resistance $R_{DSon}(P.U.)=f(T_{vj})$ $I_{DS}=1.3\text{A}, V_{GS}=10\text{V}$</p>	<p>漏源通态电阻 Normalized Drain-source on resistance $R_{DSon}=f(I_{DS}), T_{vj}=25^{\circ}\text{C}$ $V_{GS}=10\text{V}$</p>
	
<p>正向偏压特性, 二极管 Forward characteristic of Diode $I_{DS}=f(V_{DS})$</p>	<p>栅极电荷特性 MOSFET Gate charge characteristic MOSFET $V_{GS}=f(Q_g)$ $V_{DS}=750\text{V}, I_{DS}=3\text{A}, T_{vj}=25^{\circ}\text{C}$</p>
	

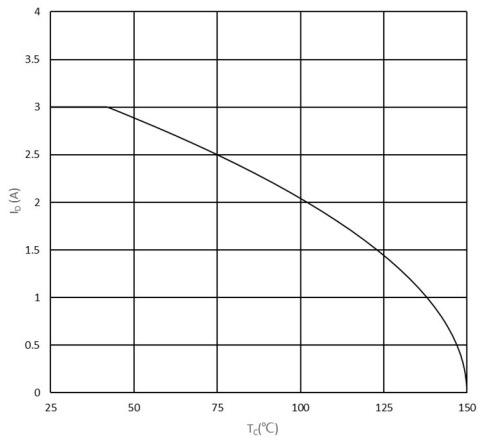
电容特性 MOSFET
Capacity characteristic MOSFET
 $C=f(V_{DS})$
 $V_{GS}=0V, T_{vj}=25^{\circ}C, f=1MHz$



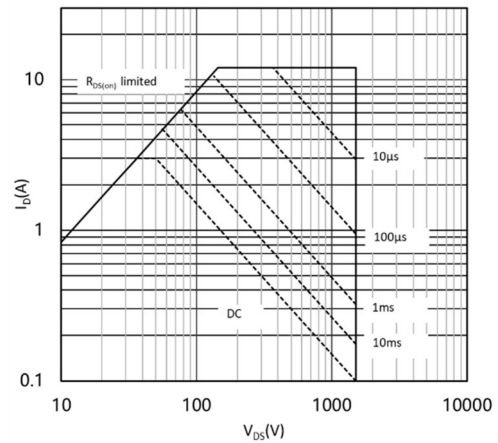
耗散功率
Maximum Power Dissipation
 $P_D=f(T_c)$



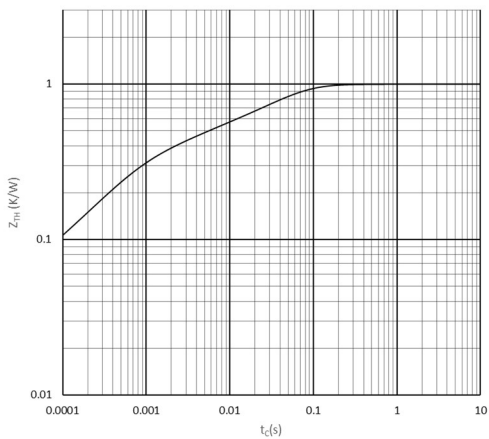
连续漏极电流
Maximum Drain Current
 $I_D=f(T_c)$



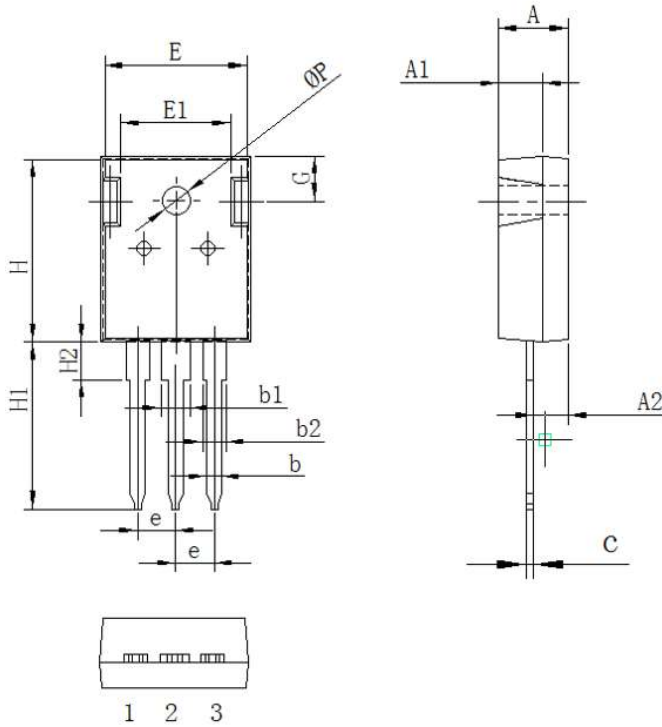
正向安全工作区
Forward Biased Safe Operating Area (FBSOA)



瞬态热阻抗 MOSFET
Transient thermal impedance MOSFET
 $Z_{thJC}=f(t)$



Package outlines / 封装尺寸



Symbol	单位 mm		
	Min	Nom	Max
A	4.8	5.00	5.20
A1	3.3	3.5	3.7
A2	2.20	2.40	2.60
b	1.00	1.2	1.40
b1	2.90	3.10	3.30
b2	1.90	2.10	2.30
c	0.50	0.60	0.70
e	5.25	5.45	5.65
E	15.2	15.7	16.2
E1	10.2	10.7	11.2
H	20.8	21	21.2
H1	19.5	20.0	20.5
H2	4.00	4.20	4.40
G	5.60	5.80	600
ΦP	3.50	3.70	3.90